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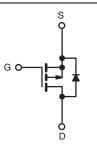
# Vishay Siliconix

COMPLIANT

# **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	- 200				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	1.5			
Q <sub>g</sub> (Max.) (nC)	15				
Q <sub>gs</sub> (nC)	3.2				
Q <sub>gd</sub> (nC)	8.4				
Configuration	Single				





P-Channel MOSFET

#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- \_\_\_\_\_
- End Stackable
- P-Channel
- · Fast Switching
- Ease of Paralleling
- Material categorization: For definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### Note

\* Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

## **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION			
Package	HVMDIP		
Lead (Pb)-free	IRFD9220PbF		
Leau (Fb)-liee	SiHFD9220-E3		
SnPb	IRFD9220		
SILD	SiHFD9220		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	- 200	W	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 0.56	А	
		T <sub>A</sub> = 100 °C		- 0.36		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 4.5		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	80	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	- 0.56	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	0.10	mJ	
Maximum Power Dissipation T <sub>A</sub> = 25 °C		$P_{D}$	1.0	W		
Peak Diode Recovery dV/dtc			dV/dt	- 5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	7	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = -50$  V, starting  $T_J = 25$  °C, L = 17.8 mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = -3$  A (see fig. 12).
- c.  $I_{SD} \le$  3.9 A, dI/dt  $\le$  95 A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le$  150 °C.



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### d. 1.6 mm from case.

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	$R_{thJA}$	-	120	°C/W	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = - 1 mA	-	- 0.22	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	=	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		- 200 V, V <sub>GS</sub> = 0 V V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	- 100 - 500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 0.34 A <sup>b</sup>	-	-	1.5	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = -	V <sub>DS</sub> = - 50 V, I <sub>D</sub> = - 0.35 A <sup>b</sup>		-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V 0V		340	-	
Output Capacitance	C <sub>oss</sub>		$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$	-	110	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	33	-	
Total Gate Charge	Qg			-	-	15	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V	$I_D = -2.1 \text{ A}, V_{DS} = -160 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	3.2	
Gate-Drain Charge	Q <sub>gd</sub>		See fig. 6 and 16	-	-	8.4	
Turn-On Delay Time	t <sub>d(on)</sub>			-	8.8	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = -	- 100 V, I <sub>D</sub> = - 3.9 A,	-	27	-	no
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 18 \Omega$ , $R_D = 24 \Omega$ , see fig. $10^b$		=	7.3	-	ns
Fall Time	t <sub>f</sub>			=	19	-	
Internal Drain Inductance	L <sub>D</sub>	6 mm (0.25")	Between lead, 6 mm (0.25") from		4.0	-	-11
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	showing the	MOSFET symbol showing the		-	- 0.56	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	- 4.5	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = -0.56 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	- 6.3	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = - 3.9 A, dl/dt = 100 A/μs <sup>b</sup>		-	150	300	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.97	2.0	μC

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

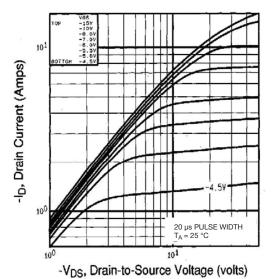


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

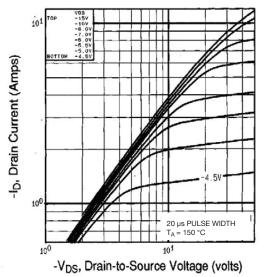


Fig. 2 - Typical Output Characteristics, T<sub>A</sub> = 150 °C

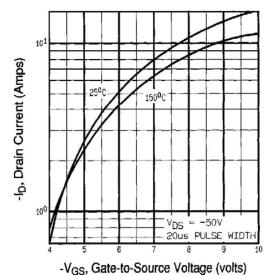


Fig. 3 - Typical Transfer Characteristics

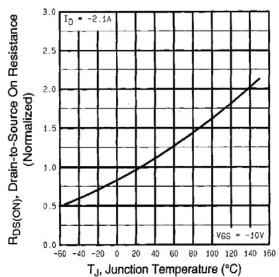


Fig. 4 - Normalized On-Resistance vs. Temperature



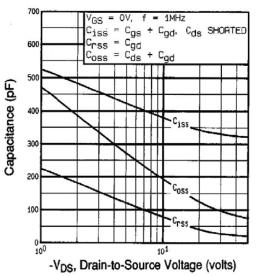


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

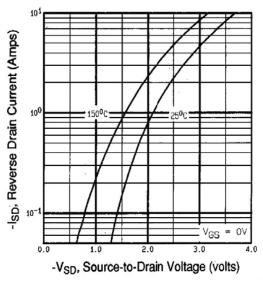


Fig. 7 - Typical Source-Drain Diode Forward Voltage

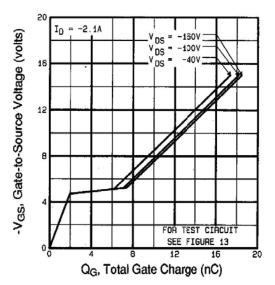


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

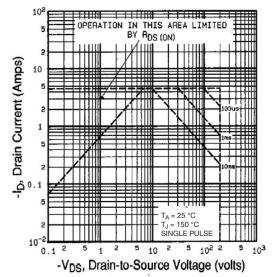


Fig. 8 - Maximum Safe Operating Area



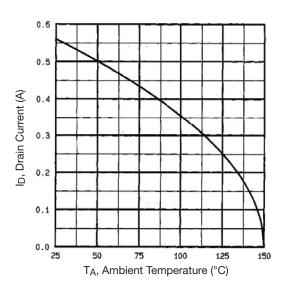


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

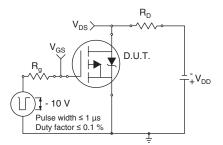


Fig. 10 - Switching Time Test Circuit

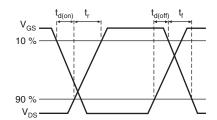


Fig. 11 - Switching Time Waveforms

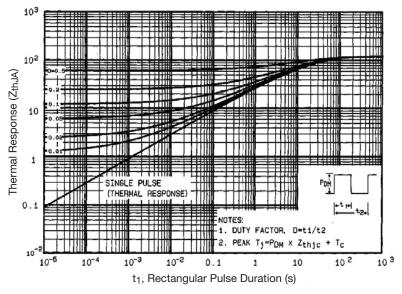


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



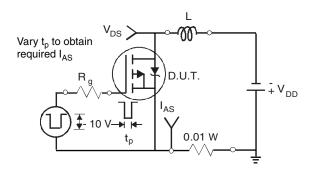


Fig. 13 - Unclamped Inductive Test Circuit

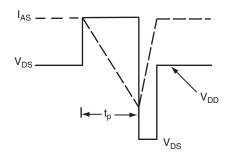


Fig. 14 - Unclamped Inductive Waveforms

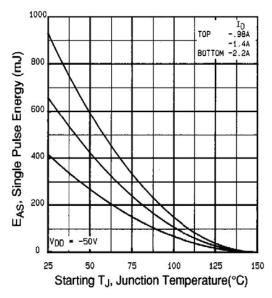


Fig. 15 - Maximum Avalanche Energy vs. Drain Current

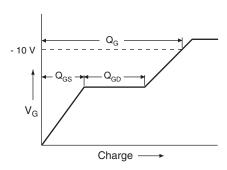


Fig. 16 - Basic Gate Charge Waveform

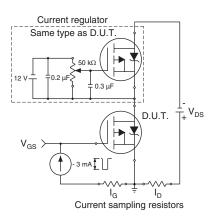
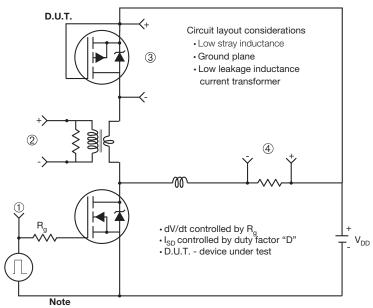


Fig. 17 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

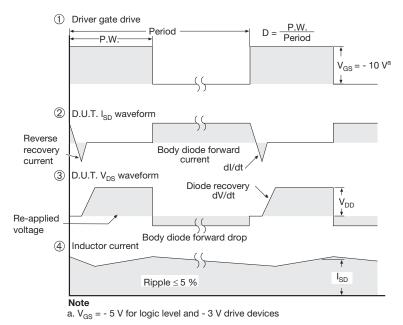
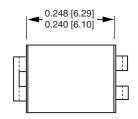


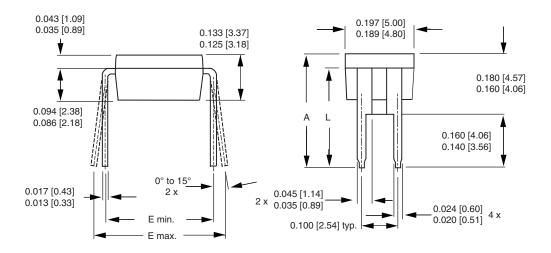
Fig. 18 - For P-Channel

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# **HVM DIP** (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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